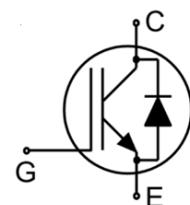


Trench Field-Stop Technology IGBT

Features

- 1200V, 50A
- $V_{CE(sat)(typ.)} = 1.85V$ @ $V_{GE}=15V$, $I_C=50A$
- Low Switching Losses
- $V_{CE(sat)}$ with Positive Temperature Coefficient
- Pb-free Lead Plating; RoHS Compliant



Applications

- Frequency Converters
- Uninterrupted Power Supply
- Air Conditioning
- Motor Drives

Key Performance and Package Parameters

Order codes	V_{CE}	I_C	V_{CEsat} , $T_{vj}=25^\circ C$	T_{vjmax}	Marking	Package
XD050H120CX1S4	1200V	50A	1.85V	175°C	D50H120CX1	TO-247-PLUS

Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Continuous Collector Current ($T_c=25^\circ C$)	100	A
	Continuous Collector Current ($T_c=100^\circ C$)	50	A
I_{CM}	Pulsed Collector Current (Note 1)	200	A
I_F	Diode Forward Current ($T_c=25^\circ C$)	100	A
	Diode Forward Current ($T_c=100^\circ C$)	50	A
P_D	Maximum Power Dissipation ($T_c=25^\circ C$)	714	W
	Maximum Power Dissipation ($T_c=100^\circ C$)	357	W
T_J	Operating Junction Temperature Range	-40 to 175	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case for IGBT	0.21	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case for Diode	0.39	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	40	°C/W

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted.)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{CES}	Collector-Emitter Breakdown Voltage	$V_{\text{GE}}=0\text{V}, I_{\text{C}}=500\mu\text{A}$	1200	---	---	V
I_{CES}	Collector-Emitter Leakage Current	$V_{\text{CE}}=1200\text{V}, V_{\text{GE}}=0\text{V}$	---	---	350	μA
I_{GES}	Gate Leakage Current, Forward	$V_{\text{GE}}=20\text{V}, V_{\text{CE}}=0\text{V}$	---	---	100	nA
	Gate Leakage Current, Reverse	$V_{\text{GE}}=-20\text{V}, V_{\text{CE}}=0\text{V}$	---	---	-100	nA
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GE}}=V_{\text{CE}}, I_{\text{C}}=1.70\text{mA}$	5.2	6.0	6.8	V
$V_{\text{CE}(\text{sat})}$	Collector-Emitter Saturation Voltage	$V_{\text{GE}}=15\text{V}, I_{\text{C}}=50\text{A}, T_j=25^\circ\text{C}$	---	1.85	2.15	V
		$V_{\text{GE}}=15\text{V}, I_{\text{C}}=50\text{A}, T_j=125^\circ\text{C}$	---	2.40	---	V
Q_G	Total Gate Charge	$V_{\text{CC}}=960\text{V}$ $V_{\text{GE}}=15\text{V}$ $I_{\text{C}}=50\text{A}$	---	290	---	nC
Q_{GE}	Gate-Emitter Charge		---	42	---	nC
Q_{GC}	Gate-Collector Charge		---	215	---	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{CC}}=600\text{V}$ $V_{\text{GE}}=\pm 15\text{V}$ $I_{\text{C}}=50\text{A}$ $R_{\text{G}}=10\Omega$ Inductive Load $T_c=25^\circ\text{C}$	---	46	---	ns
t_r	Turn-on Rise Time		---	50	---	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		---	304	---	ns
t_f	Turn-off Fall Time		---	215	---	ns
E_{on}	Turn-on Switching Loss		---	6.10	---	mJ
E_{off}	Turn-off Switching Loss		---	3.90	---	mJ
E_{ts}	Total Switching Loss		---	10.00	---	mJ
C_{ies}	Input Capacitance	$V_{\text{CE}}=25\text{V}$ $V_{\text{GE}}=0\text{V}$ $f=1\text{MHz}$	---	3600	---	pF
C_{oes}	Output Capacitance		---	331	---	pF
C_{res}	Reverse Transfer Capacitance		---	166	---	pF
I_{sc}	Short circuit collector current Max. 1000 short circuits Time between short circuits: $\geq 1.0\text{s}$	$V_{\text{GE}}=15\text{V}, V_{\text{CC}} \leq 600\text{V}$ $t_{\text{sc}} \leq 10\text{us}, T_j \leq 150^\circ\text{C}$	---	140	---	A

Diode Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=50\text{A}, T_j=25^\circ\text{C}$	---	1.80	2.3	V
		$I_F=50\text{A}, T_j=125^\circ\text{C}$	---	1.60	2.0	V
t_{rr}	Diode Reverse Recovery Time	VR=600V $I_F=50\text{A}$ $dI_F/dt=200\text{A/us}$	---	418	---	ns
I_{rr}	Diode peak Reverse Recovery Current		---	9.15	---	A
Q_{rr}	Diode Reverse Recovery Charge		---	2.14	---	uC

Note1: Repetitive rating, pulse width limited by maximum junction temperature

Typical Characteristics

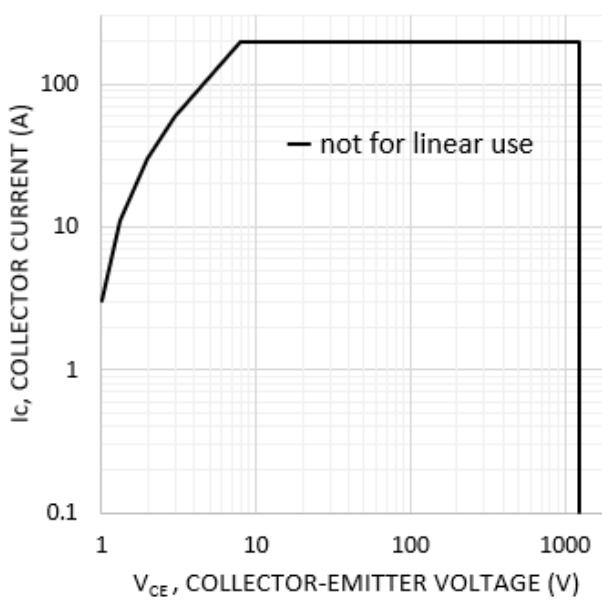


Fig. 1 Forward bias safe operating area ($D=0$,
 $T_c=25^\circ\text{C}$, $T_{vj}\leq 175^\circ\text{C}$; $V_{GE}=15\text{V}$)

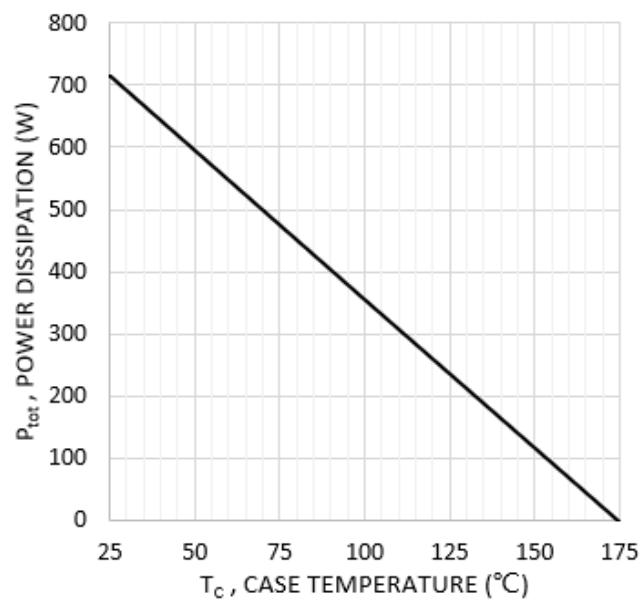


Fig. 2 Power dissipation as a function of case
 temperature ($T_{vj}\leq 175^\circ\text{C}$)

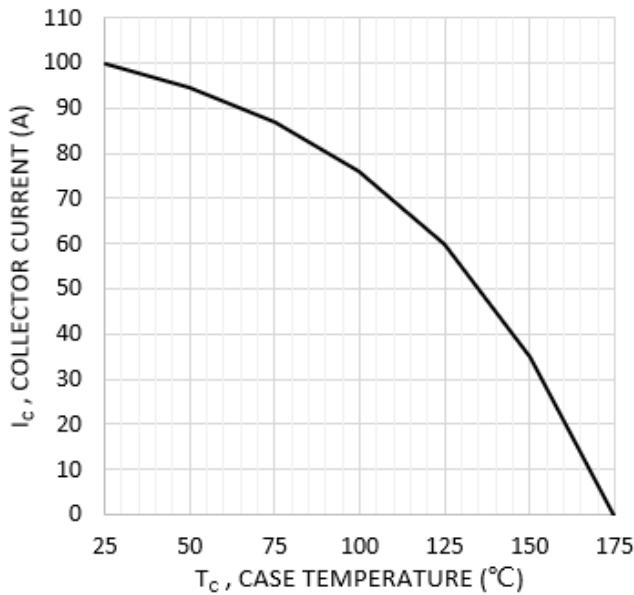


Fig. 3 Collector current as a function of case
 temperature ($V_{GE}\geq 15\text{V}$, $T_{vj}\leq 175^\circ\text{C}$)

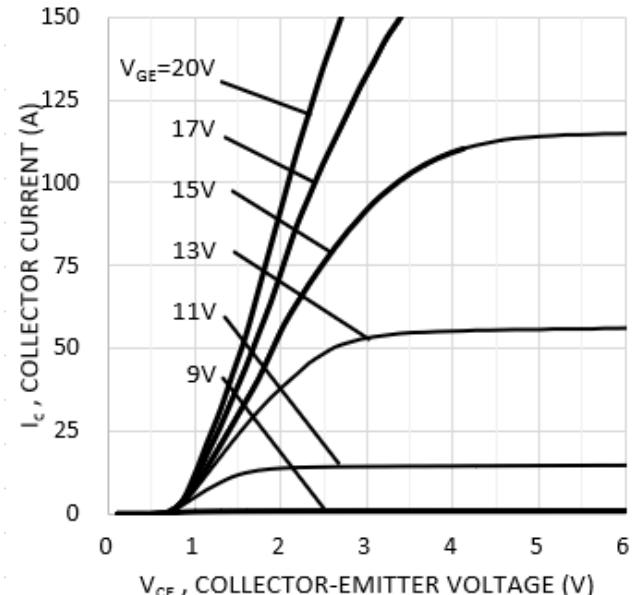


Fig. 4 Typical output characteristic ($T_{vj}=25^\circ\text{C}$)

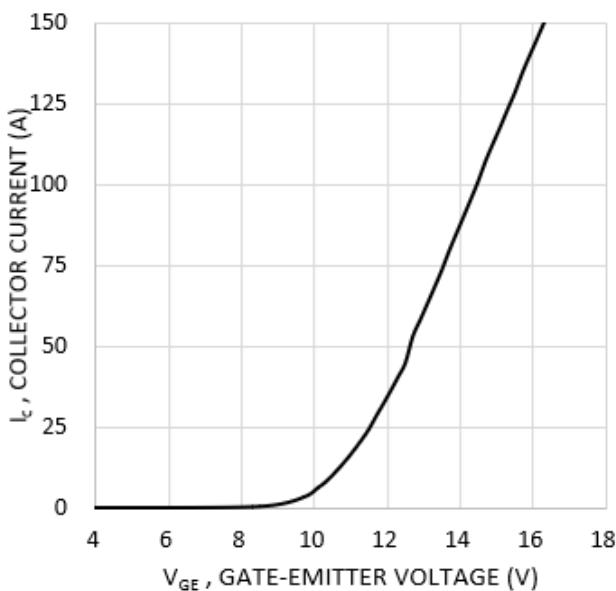


Fig. 5 Typical transfer characteristics ($V_{CE}=20V$)

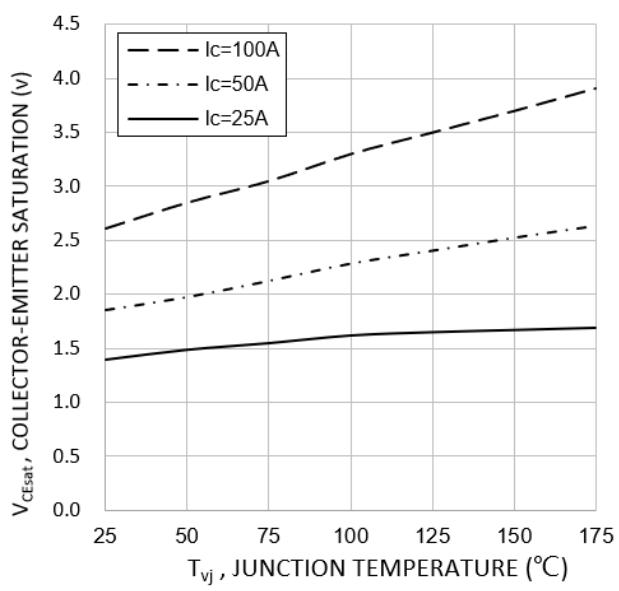


Fig. 6 Typical collector-emitter saturation voltage as a function of junction temperature ($V_{GE}=15V$)

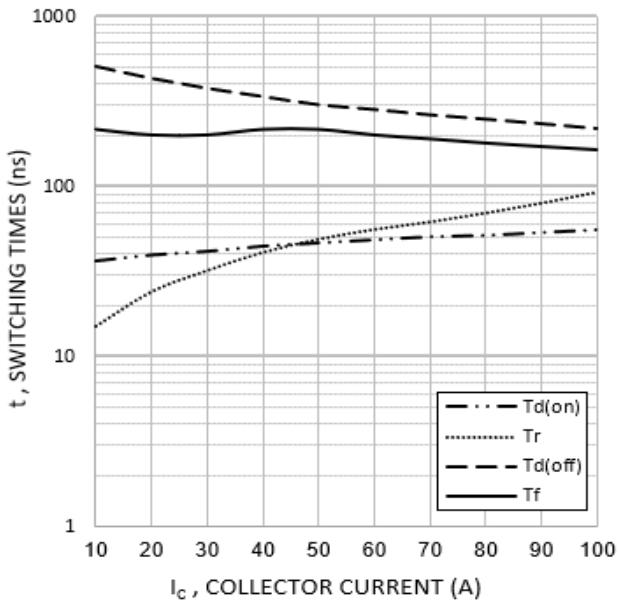


Fig. 7 Typical switching times as a function of collector current (inductive load, $T_{vj}=25^{\circ}C$, $V_{CE}=600V$, $V_{GE}=15/0V$, $r_G=10\Omega$)

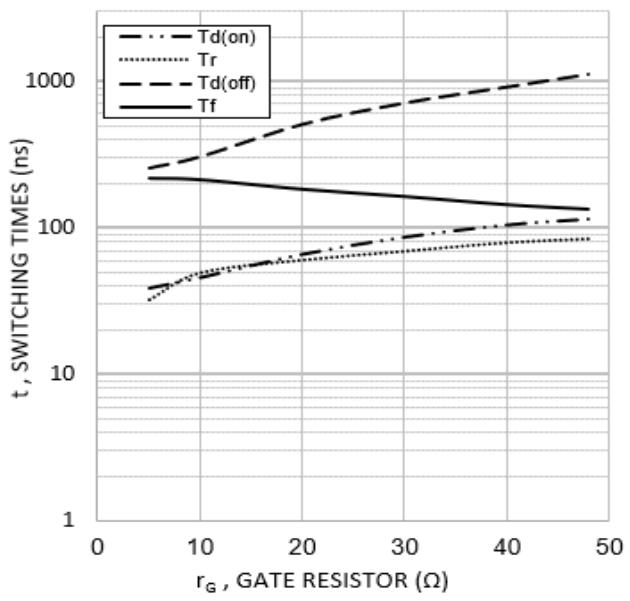


Fig. 8 Typical switching times as a function of gate resistor (inductive load, $T_{vj}=25^{\circ}C$, $V_{CE}=600V$, $V_{GE}=15/0V$, $I_c=50A$)

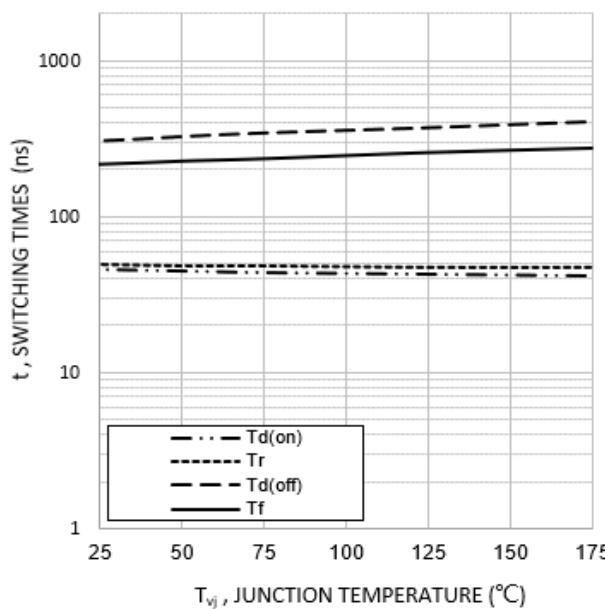


Fig. 9 Typical switching times as a function of junction temperature (inductive load, $V_{CE}=600V$, $V_{GE}=15/0V$, $I_c=50A$, $r_G=10\Omega$)

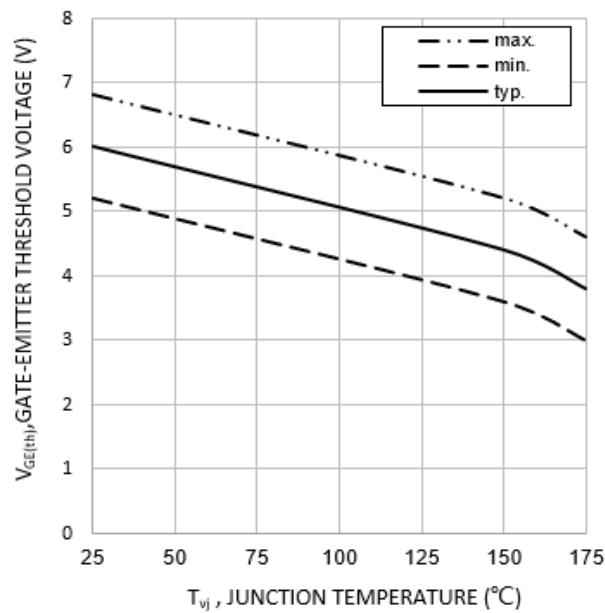


Fig. 10 Gate-emitter threshold voltage as a function of junction temperature ($I_c=1.7mA$)

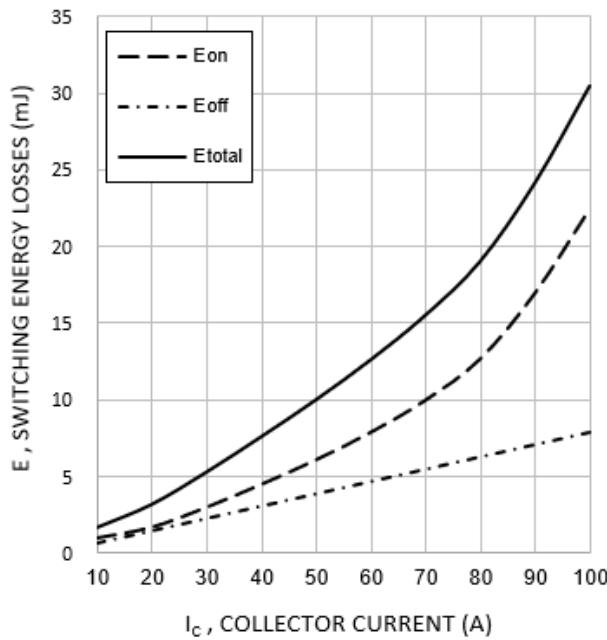


Fig. 11 Typical switching energy losses as a function of collector current (inductive load, $T_{yj}=25^\circ C$, $V_{CE}=600V$, $V_{GE}=15/0V$, $r_G=10\Omega$)

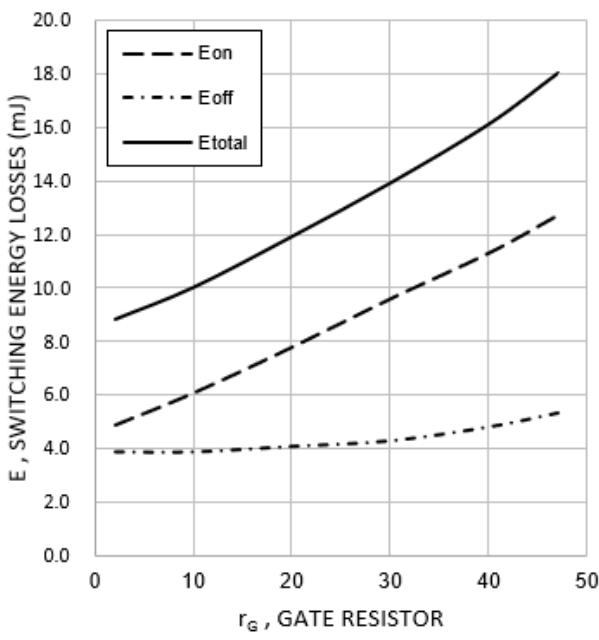


Fig. 12 Typical switching energy losses as a function of gate resistor (inductive load, $T_{yj}=25^\circ C$, $V_{CE}=600V$, $V_{GE}=15/0V$, $I_c=50A$)

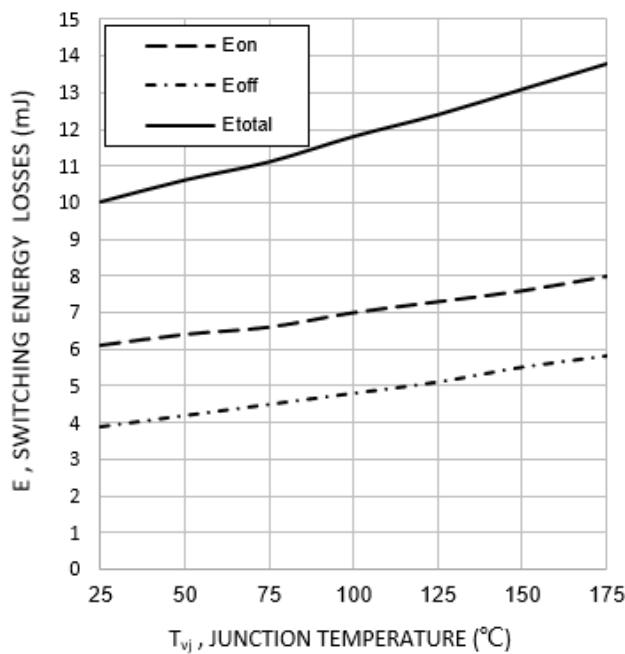


Fig. 13 Typical switching energy losses as a function of junction temperature (inductive load, $V_{CE}=600V$, $V_{GE}=15/0V$, $I_C=50A$, $r_G=10\Omega$)

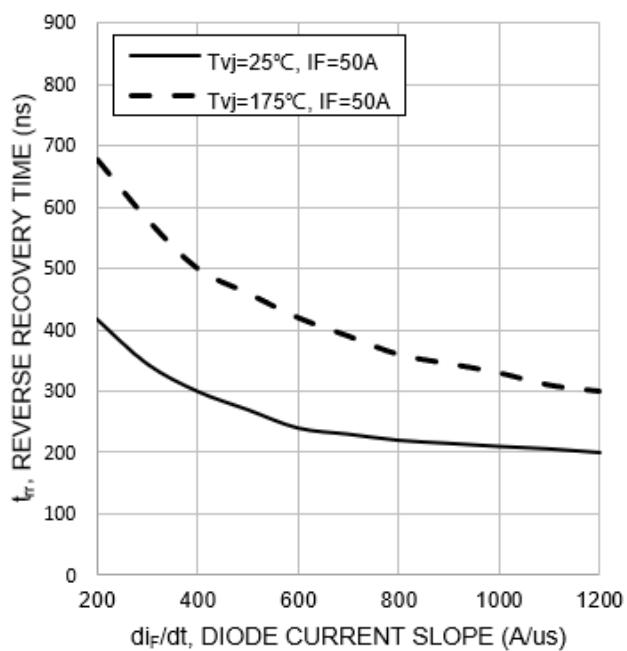


Fig. 14 Typical reverse recovery time as a function of diode current slope ($V_R=600V$)

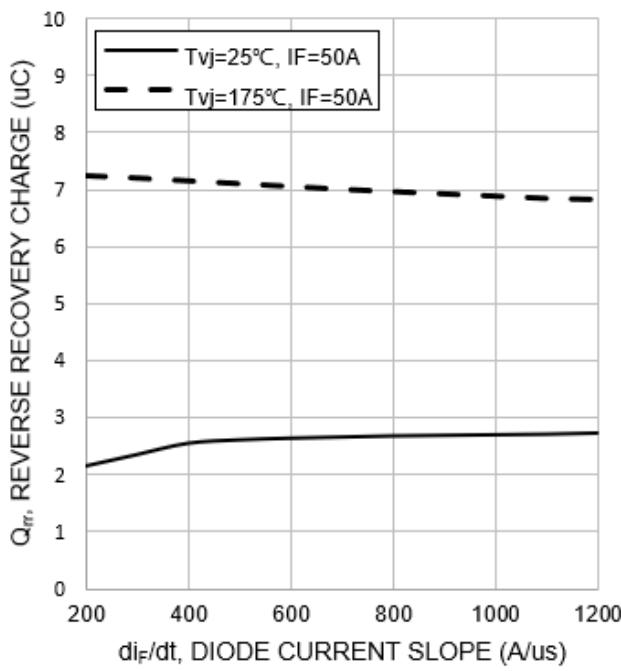


Fig. 15 Typical peak reverse recovery charge as a function of diode current slope ($V_R=400V$)

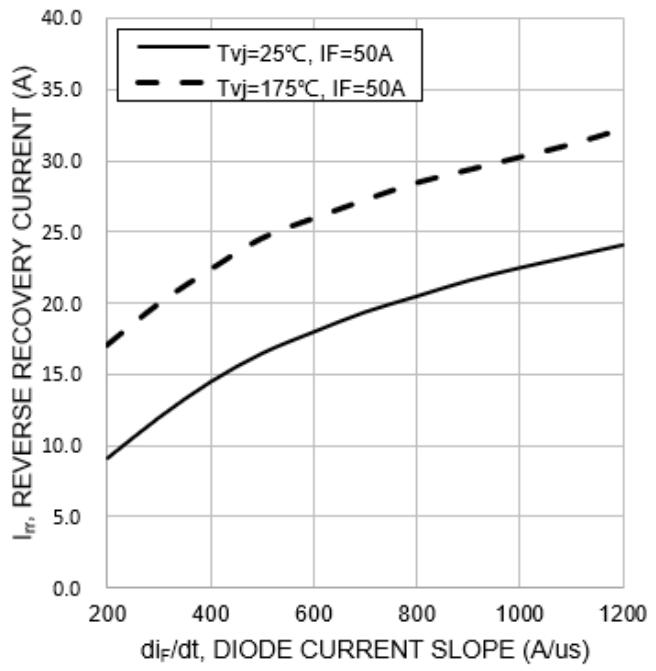


Fig. 16 Typical peak reverse recovery current as a function of diode current slope ($V_R=400V$)

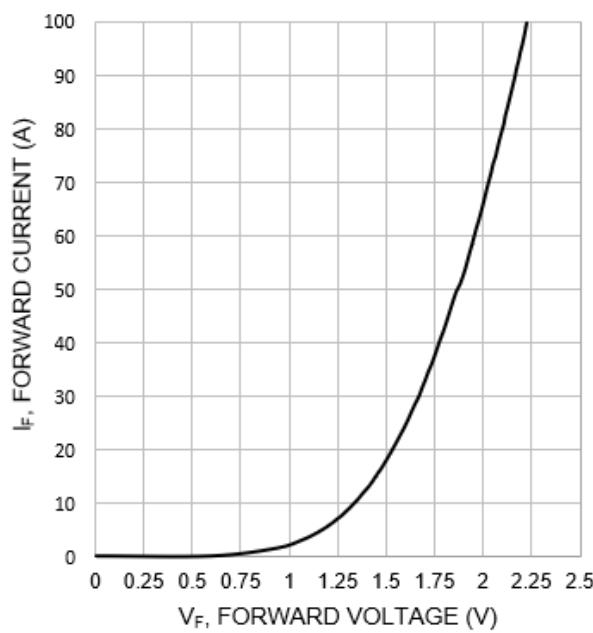


Fig. 17 Typical diode forward current as a function of forward voltage

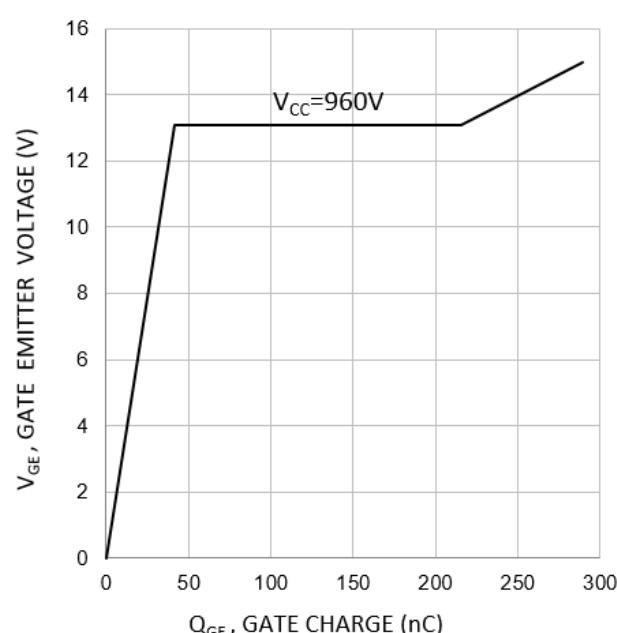


Fig. 18 Typical gate charge ($I_C=50A$)

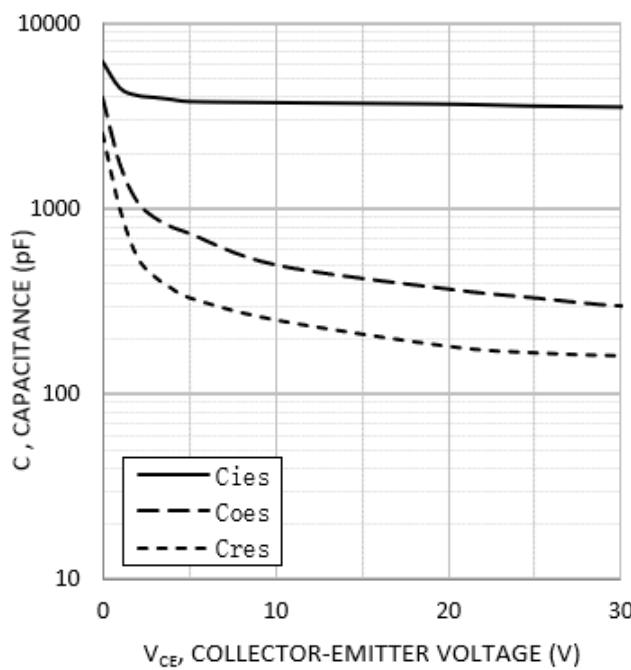


Fig. 19 Typical capacitance as a function of collector-emitter voltage ($V_{GE}=0V$, $f=1MHz$)

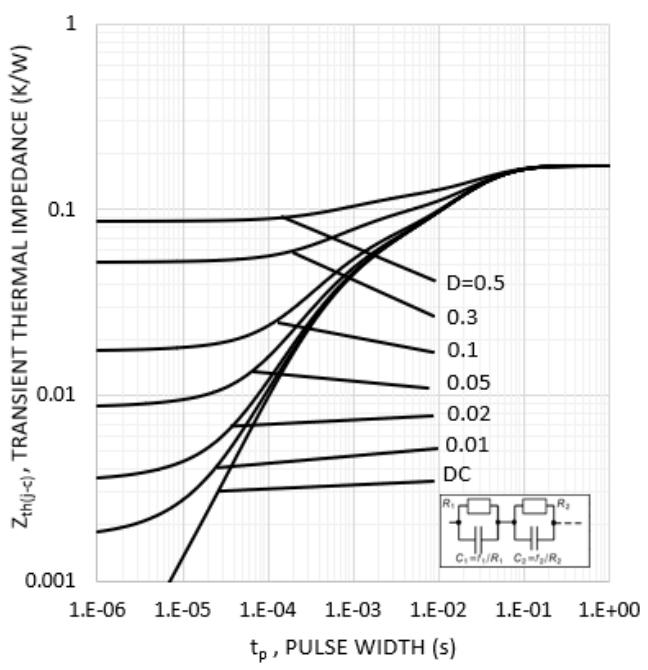
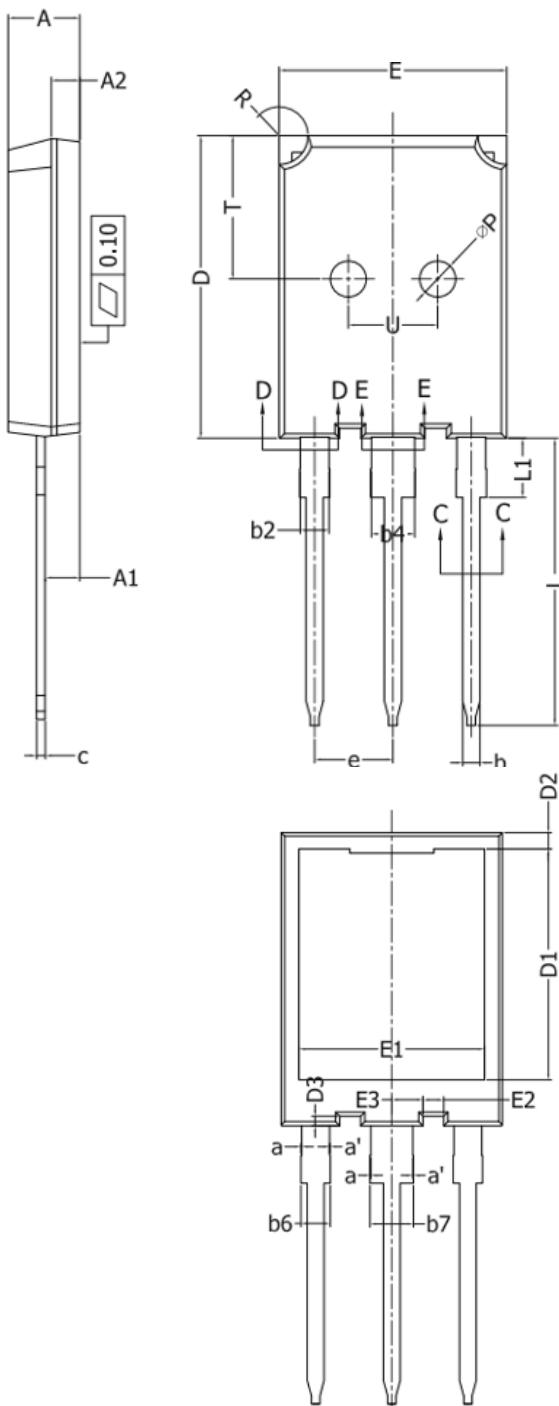


Fig. 20 IGBT transient thermal impedance ($D=t_p/T$)

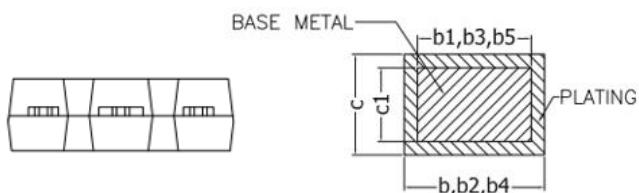
Package Information

TO-247-PLUS



COMMON DIMENSIONS
(UNITS OF MEASURE = MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
a	0	---	0.15
a'	0	---	0.15
b	1.16	---	1.26
b1	1.15	1.2	1.22
b2	1.96	---	2.06
b3	1.95	2.00	2.02
b4	2.96	---	3.06
b5	2.96	3.00	3.02
b6	---	---	2.25
b7	---	---	3.25
c	0.59	---	0.66
c1	0.59	0.60	0.66
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
D3	0.58	---	0.78
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	1.40	1.50	1.60
E3	2.12	2.22	2.32
e	5.436 BSC		
L	19.80	19.95	20.10
L1	---	---	4.30
P	2.40	2.50	2.60
R	1.90	---	2.10
T	9.80	---	10.20
U	6.00	---	6.40



SECTION C-C,D-D & E-E